

Researchers develop ultrafast semiconductors

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Professor Diana Huffaker, Institute for Compound Semiconductors, Cardiff University. Credit: Mike Hall Photography

UK researchers have developed world-leading Compound Semiconductor (CS) technology that can drive future high-speed data communications.



A team from Cardiff University's Institute for Compound Semiconductors (ICS) worked with collaborators to innovate an ultrafast and highly sensitive 'avalanche photodiode' (APD) that creates less electronic 'noise' than its silicon rivals.

APDs are highly sensitive semiconductor devices that exploit the 'photoelectric effect' - when light hits a material—to convert light to electricity.

Faster, supersensitive APDs are in demand worldwide for use in highspeed data communications and light detection and ranging (LIDAR) systems for autonomous vehicles.

A paper outlining the breakthrough in creating extremely low excess noise and high sensitivity APDs is published today in *Nature Photonics*.

Cardiff researchers led by Ser Cymru Professor Diana Huffaker, Scientific Director of ICS and Ser Cymru Chair in Advanced Engineering and Materials, partnered with the University of Sheffield and the California NanoSystems Institute, University of California, Los Angeles (UCLA) to develop the technology.

Professor Huffaker said: "Our work to develop extremely low excess noise and high sensitivity avalanche photodiodes has the potential to yield a new class of high-performance receivers for applications in networking and sensing.

"The innovation lies in the advanced materials development using molecular beam epitaxy (MBE) to "grow" the <u>compound semiconductor</u> crystal in an atom-by-atom regime. This particular material is rather complex and challenging to synthesize as it combines four different atoms requiring a new MBE methodology. The Ser Cymru MBE facility is designed specifically to realize an entire family of challenging



materials targeting future sensing solutions."

Dr. Shiyu Xie, Ser Cymru Cofund Fellow said: "The results we are reporting are significant as they operate in very low-signal environment, at <u>room temperature</u>, and very importantly are compatible with the current InP optoelectronic platform used by most commercial communication vendors.

"These APDs have a wide range of applications. In LIDAR, or 3-D laser mapping, they are used to produce high-resolution maps, with applications in geomorphology, seismology and in the control and navigation of some autonomous cars.

"Our findings can change the global field of research in APDs. The material we have developed can be a direct substitute in the current existing APDs, yielding a higher data transmission rate or enabling a much longer transmission distance."

The Ser Cymru Group within ICS is now preparing a proposal with collaborators at Sheffield for funding from UK Research and Innovation to support further work.

Cardiff University Vice-Chancellor, Professor Colin Riordan, added: "The work of Professor Huffaker's Ser Cymru Group plays a vital role in supporting the ongoing success of the wider Compound Semiconductor cluster, CS Connected, which brings together ten industry and academic partners in South Wales to develop 21st Century technologies that create economic prosperity."

Professor Huffaker added: "Our research produces direct benefits for industry. We are working closely with Airbus and the Compound Semiconductor Applications Catapult to apply this technology to future free space optics communication system."



More information: Xin Yi et al, Extremely low excess noise and high sensitivity AlAs0.56Sb0.44 avalanche photodiodes, *Nature Photonics* (2019). DOI: 10.1038/s41566-019-0477-4

Provided by Cardiff University

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